TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK2991

DC-DC Converter Relay Drive and Motor Drive Applications

- Low drain-source ON resistance $: RDS (ON) = 1.35 \Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 4.0 \text{ S (typ.)}$
- Low leakage current $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 500 \ V)$
- Enhancement mode $: V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ ID} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	500	V	
Drain-gate voltage (R	_{GS} = 20 kΩ)	V _{DGR}	500	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	۱ _D	5	А	
	Pulse (Note 1)	I _{DP}	20	A	
Drain power dissipation	n (Tc = 25°C)	PD	50	W	
Single pulse avalanche energy (Note 2)		E _{AS}	180	mJ	
Avalanche current		I _{AR}	5	A	
Repetitive avalanche energy (Note 3)		E _{AR}	4	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

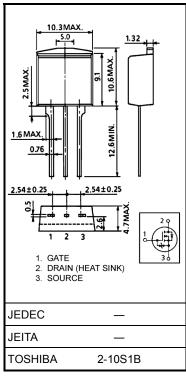
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.5	°C / W
Thermal resistance, channel to ambient	R _{th (ch−a)}	83.3	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

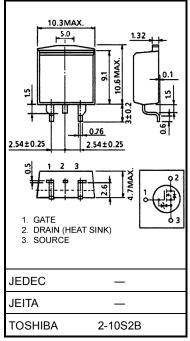
Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 12.2 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



Weight: 1.5 g (typ.)



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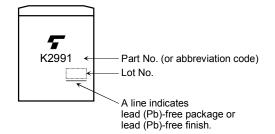
Electrical Characteristics (Ta = 25°C)

Charae	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μA
Gate-source br	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μA
Drain-source bi	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 2.5 A	_	1.35	1.50	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.5	4.0	_	S
Input capacitant	ce	C _{iss}		_	780	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	pF
Output capacitance		C _{oss}			200	_	
Switching time	Rise time	t _r	$v_{GS} \stackrel{10V}{}_{0V} \prod \qquad I_{D} = 2.5A \circ V_{OUT}$	_	12	_	
	Turn-on time	t _{on}		_	25	_	ns
	Fall time	t _f		_	15	_	
	Turn-off time	t _{off}	$\begin{array}{c} V_{DD} \rightleftharpoons 225V\\ \text{Duty} \leq 1\%, \ t_W = 10 \mu s \end{array}$	_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	17	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 5 A		11	_	nC
Gate-drain ("miller") charge		Q _{gd}			6	_	

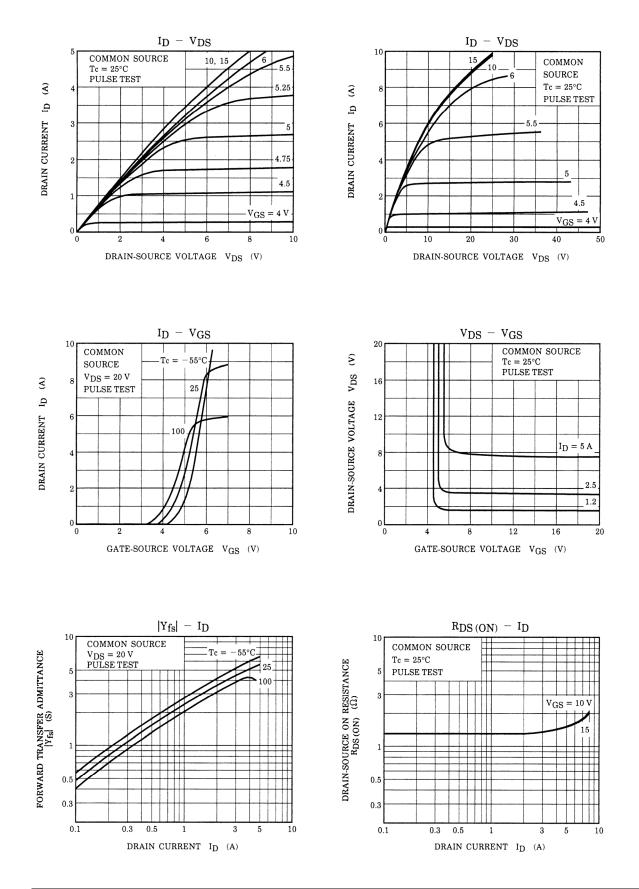
Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	5	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	20	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V, dI _{DR} / dt = 100 A / μs	_	1400	_	ns
Reverse recovery charge	Q _{rr}		_	9	_	μC

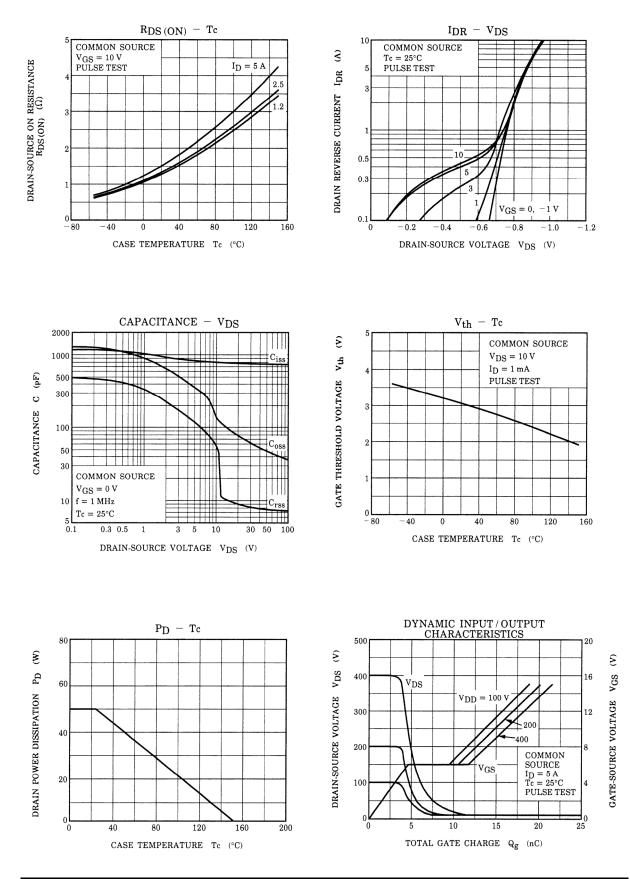
Marking

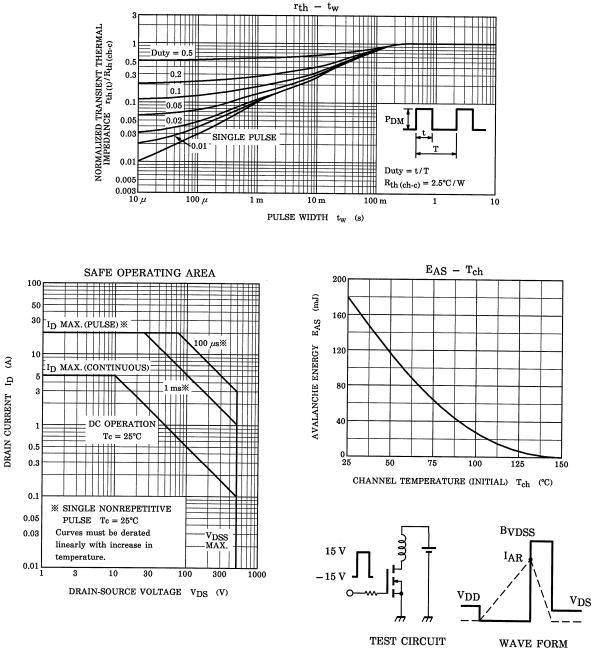


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 $\begin{array}{ll} \mathrm{R}_{\mathrm{G}} = 25 \ \Omega \\ \mathrm{V}_{\mathrm{DD}} = 90 \ \mathrm{V}, \ \mathrm{L} = 12.2 \ \mathrm{mH} \end{array} \qquad \mathrm{E}_{\mathrm{AS}} = \frac{1}{2} \cdot \mathrm{L} \cdot \mathrm{I}^2 \cdot \left(\frac{\mathrm{B} \mathrm{V}\mathrm{D}\mathrm{SS}}{\mathrm{B} \mathrm{V}\mathrm{D}\mathrm{SS} - \mathrm{V}\mathrm{D}\mathrm{D}} \right) \end{array}$

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